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#### TOSHIBA PHOTOCOUPLER PHOTO RELAY

# T L P 3 1 2 1

# MEASUREMENT INSTRUMENTS LOGIC IC TESTERS / MEMORY TESTERS BOARD TESTERS / SCANNERS

The TOSHIBA TLP3121 Mini-flat photorelay is a small-outline photorelay, suitable for surface-mount assembly. The TLP3121 consists of a GaAs infrared-emitting diode optically coupled to a photo-MOS FET and housed in a 4-pin package.

Its characteristics include low OFF-state current and low output pin capacitance.

### FEATURES

- 4 pin SOP (2.54SOP4)
- : 2.1 mm high, 2.54 mm pitch
- 1-Form-A
- Peak Off-State Voltage : 80 V (MIN.)
- Trigger LED Current : 4 mA (MAX.)
- On-State Current : 350 mA (MAX.)
- On-State Resistance  $: 1.2 \Omega$  (MAX.)
- Output Capacitance
- Isolation Voltage
- : 40 pF (MAX.) : 1500 Vrms (MIN.)



## SCHEMATIC





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#### MAXIMUM RATINGS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
LED	Forward Current	١ <sub>F</sub>	50	mA
	Forward Current Derating (Ta $\ge$ 25°C)	∆I <sub>F</sub> /°C	-0.5	mA/°C
	Reverse Voltage	V <sub>R</sub>	5	V
	Junction Temperature	Tj	125	°C
DETECTOR	Off-State Output Terminal Voltage	V <sub>OFF</sub>	80	V
	On-State Current	I <sub>ON</sub>	350	mA
	On-State Current Derating (Ta ≥ 25°C)	∆l <sub>ON</sub> /°C	-3.5	mA/°C
	Junction Temperature	Tj	125	°C
Stora	ge Temperature Range	T <sub>stg</sub>	-40~125	°C
Oper	ating Temperature Range	T <sub>opr</sub>	-20~85	°C
Lead	Soldering Temperature (10 s)	T <sub>sol</sub>	260	°C
Isolat	ion Voltage (AC, 1 minute, R.H. $\leq$ 60%) (NOTE1)	BVS	1500	Vrms

(NOTE1) : Device considered a two-terminal device : Pins 1 and, 2 shorted together, and pins 3 and 4 shorted together.

### **RECOMMENDED OPERATING CONDITIONS**

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply Voltage	V <sub>DD</sub>	_	_	64	V
Forward Current	١ <sub>F</sub>	5	—	30	mA
On-State Current	I <sub>ON</sub>	_	—	350	mA
Operating Temperature	T <sub>opr</sub>	25	_	60	°C

# INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
	Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse Current	I <sub>R</sub>	$V_R = 5 V$	—	—	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	—	15		pF
DETECTOR	Off-State Current	I <sub>OFF</sub>	V <sub>OFF</sub> = 30 V, Ta = 50°C	_	200	1000	pА
	Capacitance	C <sub>OFF</sub>	V = 0, f = 100 MHz	_	30	40	pF

## COUPLED ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Trigger LED Current	I <sub>FT</sub>	I <sub>ON</sub> = 350 mA	—	1	4	mA
Return LED Current	I <sub>FC</sub>	I <sub>OFF</sub> = 10 μA	0.2	0.75	_	mA
On-State Resistance	R <sub>ON</sub>	I <sub>ON</sub> = 350 mA, I <sub>F</sub> = 5 mA		1.0	1.2	Ω

## **ISOLATION CHARACTERISTICS (Ta = 25^{\circ}C)**

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Capacitance Input to Output	CS	$V_S = 0 V$ , f = 1 MHz	_	0.8	_	pF
Isolation Resistance	R <sub>S</sub>	$V_S = 500 \text{ V}, \text{ R.H.} \leq 60\%$	$5 \times 10^{10}$	10 <sup>14</sup>	_	Ω
		AC, 1 minute	1500	_	_	Vrms
Isolation Voltage	BVS	AC, 1 second (in oil)	_	3000	_	VIIIS
		DC, 1 minute (in oil)		3000		Vdc

# SWITCHING CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Turn-on Time	t <sub>ON</sub>	$R_L = 200 \Omega$ (NOTE 2	—	300	500	
Turn-off Time	tOFF	$V_{DD} = 20 \text{ V}, \text{ I}_{\text{F}} = 5 \text{ mA}$	—	300	500	μs

(NOTE 2) : SWITCHING TIME TEST CIRCUIT

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